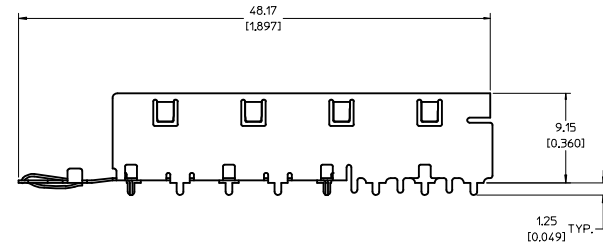
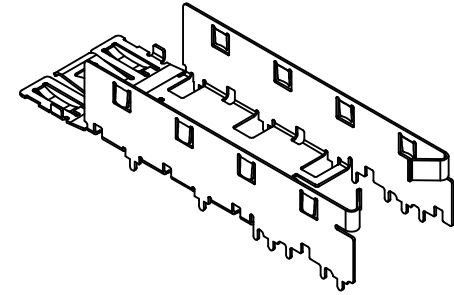
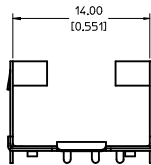
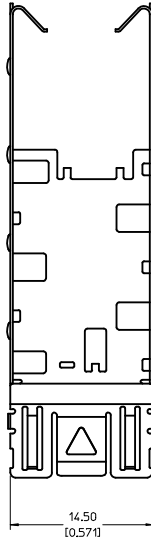


NOTES:

1. MATERIAL: COPPER ALLOY
2. PLATING: BRIGHT TIN
2.54 MICROMETERS TIN (MIN)
OVER 0.76 MICROMETERS (MIN) NICKEL
3. FOR DETAILS OF PCB AND BEZEL LAYOUT REFER
TO DOCUMENT SD-73927-100.
4. THIS PRODUCT NOT INTENDED FOR LEAD FREE, (RoHS), REFLOW PROCESS.
REFLOW TEMPERATURE SHOULD NOT EXCEED 180°C
5. FOR RoHS COMPLIANT REPLACEMENTS REFER TO MOLEX SERIES 74737.

ENTER DESCRIPTION EC NO: UST2006-0264 DRAWN BY: DRINKS IMONSON 2006/07/03 CHECKED BY: CHUCK BRUSSELL 2006/07/06 APPR: BRUSSELL 2006/07/24 A	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED) <table border="1"> <thead> <tr> <th></th> <th>mm</th> <th>INCH</th> </tr> </thead> <tbody> <tr> <td>4 PLACES ±</td> <td>---</td> <td>---</td> </tr> <tr> <td>3 PLACES ±</td> <td>---</td> <td>±.005</td> </tr> <tr> <td>2 PLACES ±</td> <td>±0.13</td> <td>±.01</td> </tr> <tr> <td>1 PLACE ±</td> <td>±0.25</td> <td>---</td> </tr> <tr> <td>ANGULAR</td> <td colspan="2">± 1 °</td> </tr> </tbody> </table>		mm	INCH	4 PLACES ±	---	---	3 PLACES ±	---	±.005	2 PLACES ±	±0.13	±.01	1 PLACE ±	±0.25	---	ANGULAR	± 1 °		DIMENSION STYLE MM/IN DRAWN BY: KS IMONSON DATE: 2005/10/12 CHECKED BY: BRUSSELL DATE: 2005/10/12 APPROVED BY: BRUSSELL DATE: 2005/10/12	SCALE 4:1 DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
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ANGULAR	± 1 °																						
MATERIAL NO. 739270040 DOCUMENT NO. SD-73927-0040 SHEET NO. 1 OF 1	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		TITLE SFP CAGE BASE SOLDER POSTS FOR WAVE SOLDER MOLEX INCORPORATED THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																				



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4. THIS PRODUCT NOT INTENDED FOR LEAD FREE, REFLOW PROCESS. REFLOW TEMPERATURE SHOULD NOT EXCEED 180°C. FOR REFLOW PROCESSES GREATER THAN 180°C, REFER TO MOLEX SERIES 74737.

ENTER DESCRIPTION IEC NO: 2006/07/29 DRAWN BY: DRW:CCOX CHKD: 2006/08/07 APPR: BRUSSELL 2006/08/15 REV: DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION																		
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